SKM150GB17E4



SEMITRANS® 2

IGBT4 Modules

SKM150GB17E4

Features*

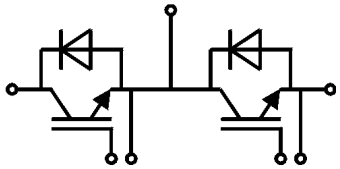
- IGBT4 = 4th generation medium fast trench IGBT (Infineon)
- CAL4 = Soft switching 4th generation CAL-Diode
- Insulated copper baseplate using DBC Technology (Direct Copper Bonding)
- With integrated Gate resistor
- For switching frequencies up to 8kHz
- UL recognized, file no. E63532

Typical Applications

- AC inverter drives
- UPS
- Electronic welders
- Wind power
- Public transport

Remarks

- Case temperature limited to T_C = 125°C max.
- Recommended $T_{j,op}$ = -40 ... +150°C
- Product reliability results valid for T_j = 150°C



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Absolute Maximum Ratings

Symbol	Conditions		Values	Unit
IGBT				
V_{CES}	T_j = 25 °C		1700	V
I_C	T_j = 175 °C	T_c = 25 °C	248	A
		T_c = 80 °C	189	A
I_{Cnom}			150	A
I_{CRM}			450	A
V_{GES}			-20 ... 20	V
t_{psc}	V_{CC} = 1000 V $V_{GE} \leq$ 15 V $V_{CES} \leq$ 1700 V	T_j = 150 °C	10	µs
T_j			-40 ... 175	°C
Inverse diode				
V_{RRM}	T_j = 25 °C		1700	V
I_F	T_j = 175 °C	T_c = 25 °C	169	A
		T_c = 80 °C	125	A
I_{FRM}			300	A
I_{FSM}	t_p = 10 ms, sin 180°, T_j = 25 °C		950	A
T_j			-40 ... 175	°C
Module				
$I_{t(RMS)}$			200	A
T_{stg}	module without TIM		-40 ... 125	°C
V_{isol}	AC sinus 50 Hz, t = 1 min		4000	V

Characteristics

Symbol	Conditions		min.	typ.	max.	Unit
IGBT						
$V_{CE(sat)}$	I_C = 150 A V_{GE} = 15 V chiplevel	T_j = 25 °C		1.90	2.20	V
		T_j = 150 °C		2.31	2.60	V
V_{CE0}	chiplevel	T_j = 25 °C		1.10	1.20	V
		T_j = 150 °C		1.00	1.10	V
r_{CE}	V_{GE} = 15 V chiplevel	T_j = 25 °C		5.3	6.7	mΩ
		T_j = 150 °C		8.7	10.0	mΩ
$V_{GE(th)}$	V_{GE}=V_{CE}, I_C = 6 mA		5.2	5.8	6.4	V
I_{CES}	V_{GE} = 0 V, V_{CE} = 1700 V, T_j = 25 °C				2.0	mA
C_{ies}	V_{CE} = 25 V V_{GE} = 0 V	f = 1 MHz		11.8		nF
C_{oes}		f = 1 MHz		0.43		nF
C_{res}		f = 1 MHz		0.38		nF
Q_G	V_{GE} = - 8 V...+ 15 V			1200		nC
R_{Gint}	T_j = 25 °C			5.0		Ω
$t_{d(on)}$	V_{CC} = 1200 V I_C = 150 A V_{GE} = +15/-15 V $R_{G\ on}$ = 2 Ω $R_{G\ off}$ = 2 Ω di/dt_{on} = 3500 A/µs di/dt_{off} = 890 A/µs dv/dt = 5440 V/µs	T_j = 150 °C		234		ns
t_r		T_j = 150 °C		41		ns
E_{on}		T_j = 150 °C		67		mJ
$t_{d(off)}$		T_j = 150 °C		671		ns
t_f		T_j = 150 °C		144		ns
E_{off}		T_j = 150 °C		59		mJ
$R_{th(j-c)}$	per IGBT				0.162	K/W
$R_{th(c-s)}$	per IGBT (λ_{grease}=0.81 W/(m*K))			0.072		K/W
$R_{th(c-s)}$	per IGBT, pre-applied phase change material			0.05		K/W



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- Wind power
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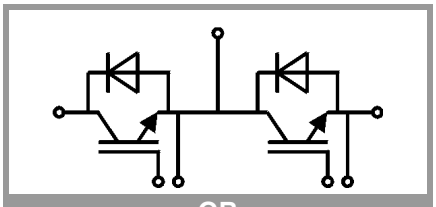
Remarks

- Case temperature limited to T_C = 125°C max.
- Recommended $T_{j,op}$ = -40 ... +150°C
- Product reliability results valid for T_j = 150°C

Characteristics

Symbol	Conditions		min.	typ.	max.	Unit
Inverse diode						
$V_F = V_{EC}$	I_F = 150 A V_{GE} = 0 V chiplevel	T_j = 25 °C		1.98	2.37	V
		T_j = 150 °C		2.12	2.52	V
V_{F0}	chiplevel	T_j = 25 °C		1.32	1.56	V
		T_j = 150 °C		1.08	1.22	V
r_F	chiplevel	T_j = 25 °C		4.4	5.4	mΩ
		T_j = 150 °C		6.9	8.7	mΩ
I_{RRM}	I_F = 150 A di/dt_{off} = 2410 A/µs V_{GE} = -15 V V_{CC} = 1200 V	T_j = 150 °C		77		A
Q_{rr}		T_j = 150 °C		46		µC
E_{rr}		T_j = 150 °C		32		mJ
$R_{th(j-c)}$	per diode				0.345	K/W
$R_{th(c-s)}$	per diode (λ_{grease}=0.81 W/(m*K))			0.095		K/W
$R_{th(c-s)}$	per diode, pre-applied phase change material			0.067		K/W
Module						
L_{CE}				30		nH
$R_{CC'+EE'}$	measured per switch	T_C = 25 °C		0.65		mΩ
		T_C = 125 °C		1.09		mΩ
$R_{th(c-s)1}$	calculated without thermal coupling			0.0205		K/W
$R_{th(c-s)2}$	including thermal coupling, T_s underneath module (λ_{grease}=0.81 W/(m*K))			0.031		K/W
$R_{th(c-s)2}$	including thermal coupling, T_s underneath module, pre-applied phase change material			0.022		K/W
M_s	to heat sink M6		3		5	Nm
M_t		to terminals M5	2.5		5	Nm
						Nm
w					160	g



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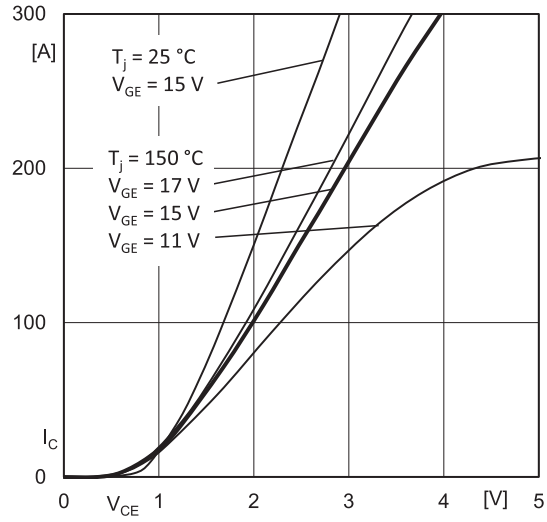


Fig. 1: Typ. output characteristic, inclusive $R_{CC'+EE'}$

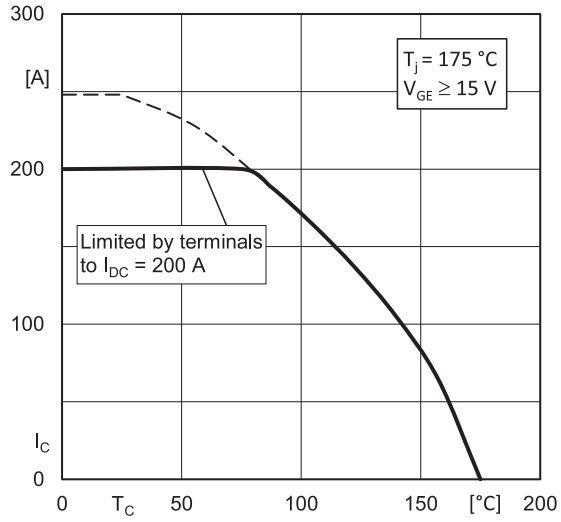


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

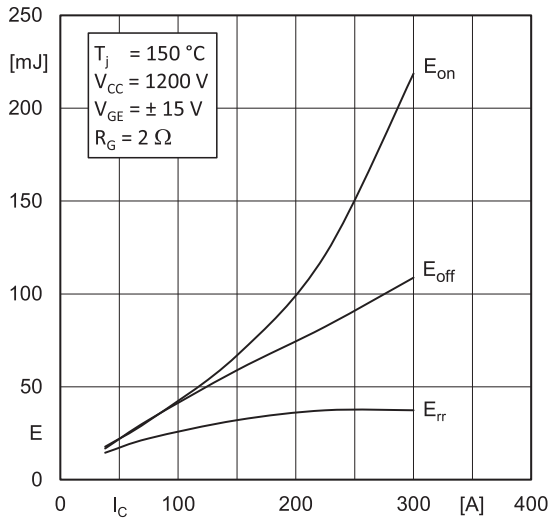


Fig. 3: Typ. turn-on /-off energy = f (I_C)

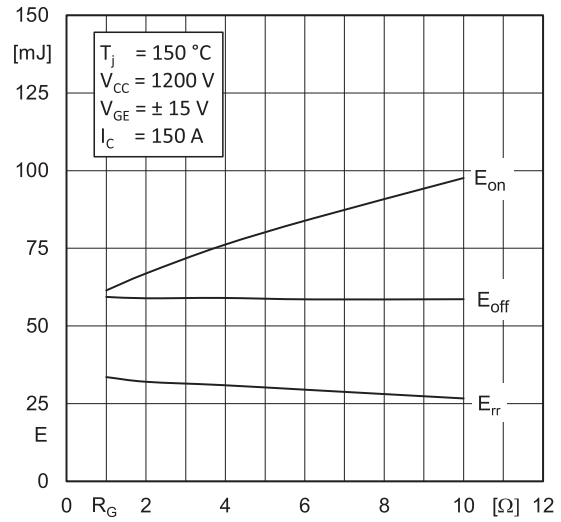


Fig. 4: Typ. turn-on /-off energy = f (R_G)

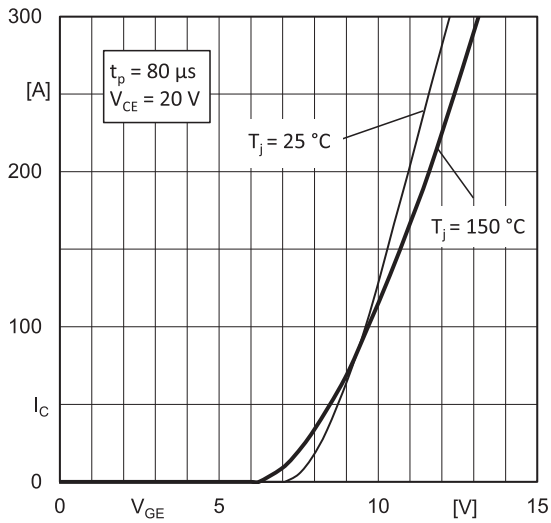


Fig. 5: Typ. transfer characteristic

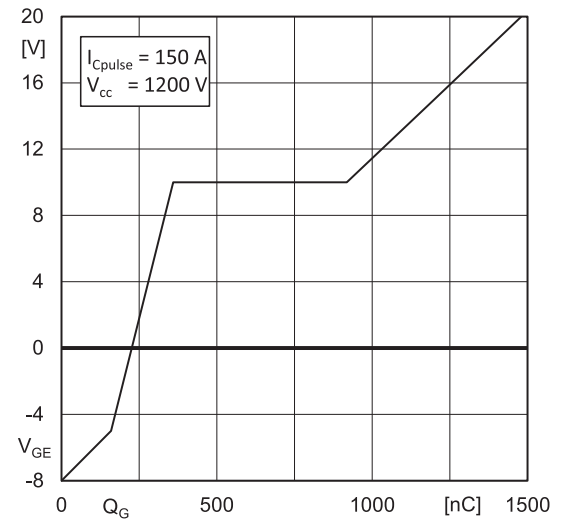


Fig. 6: Typ. gate charge characteristic

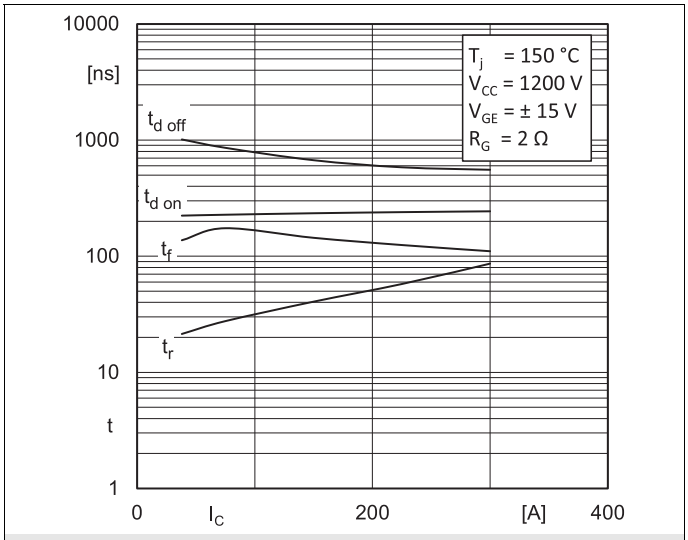


Fig. 7: Typ. switching times vs. I_C

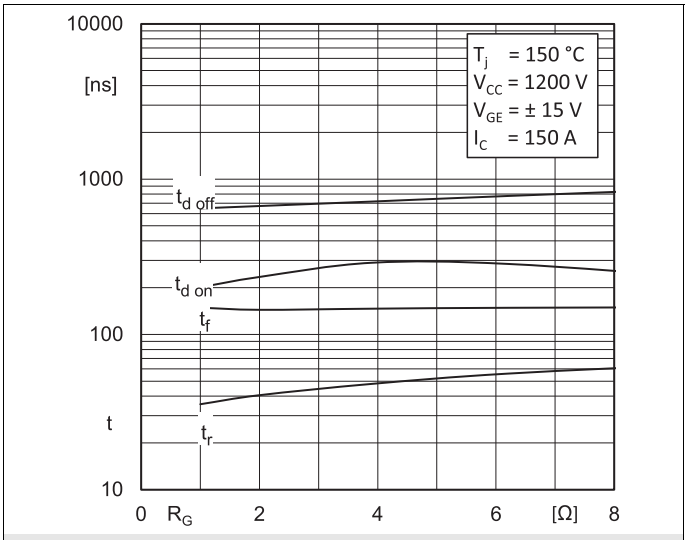


Fig. 8: Typ. switching times vs. gate resistor R_G

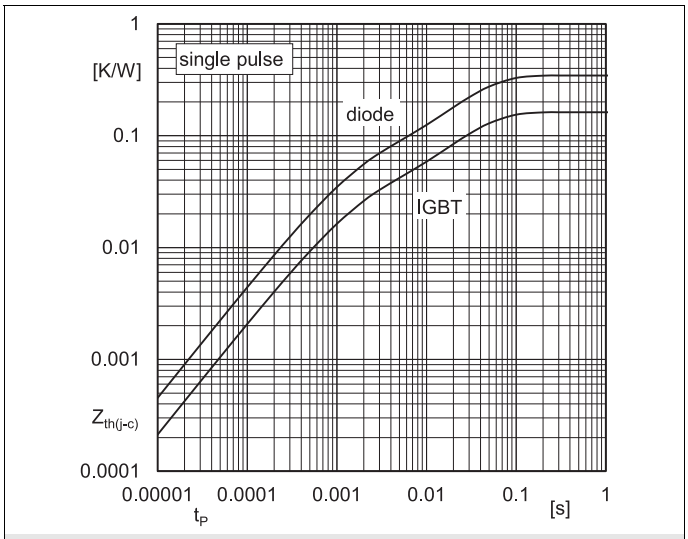


Fig. 9: Transient thermal impedance

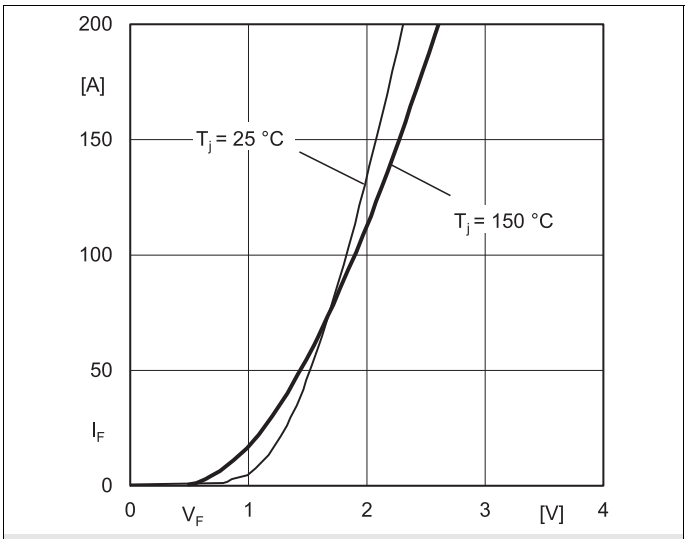


Fig. 10: Typ. CAL diode forward charact., incl. $R_{CC'+EE'}$

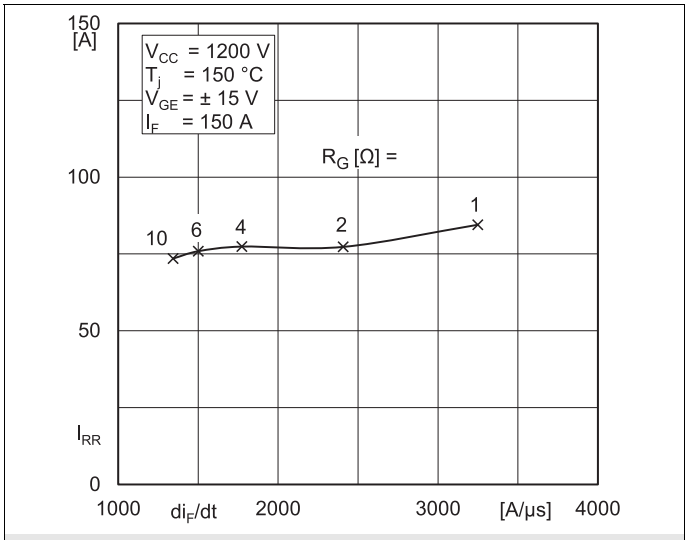


Fig. 11: Typ. CAL diode peak reverse recovery current

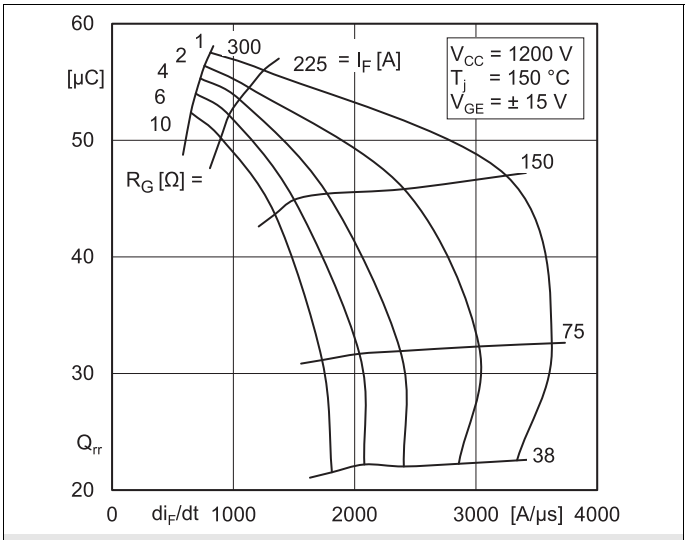
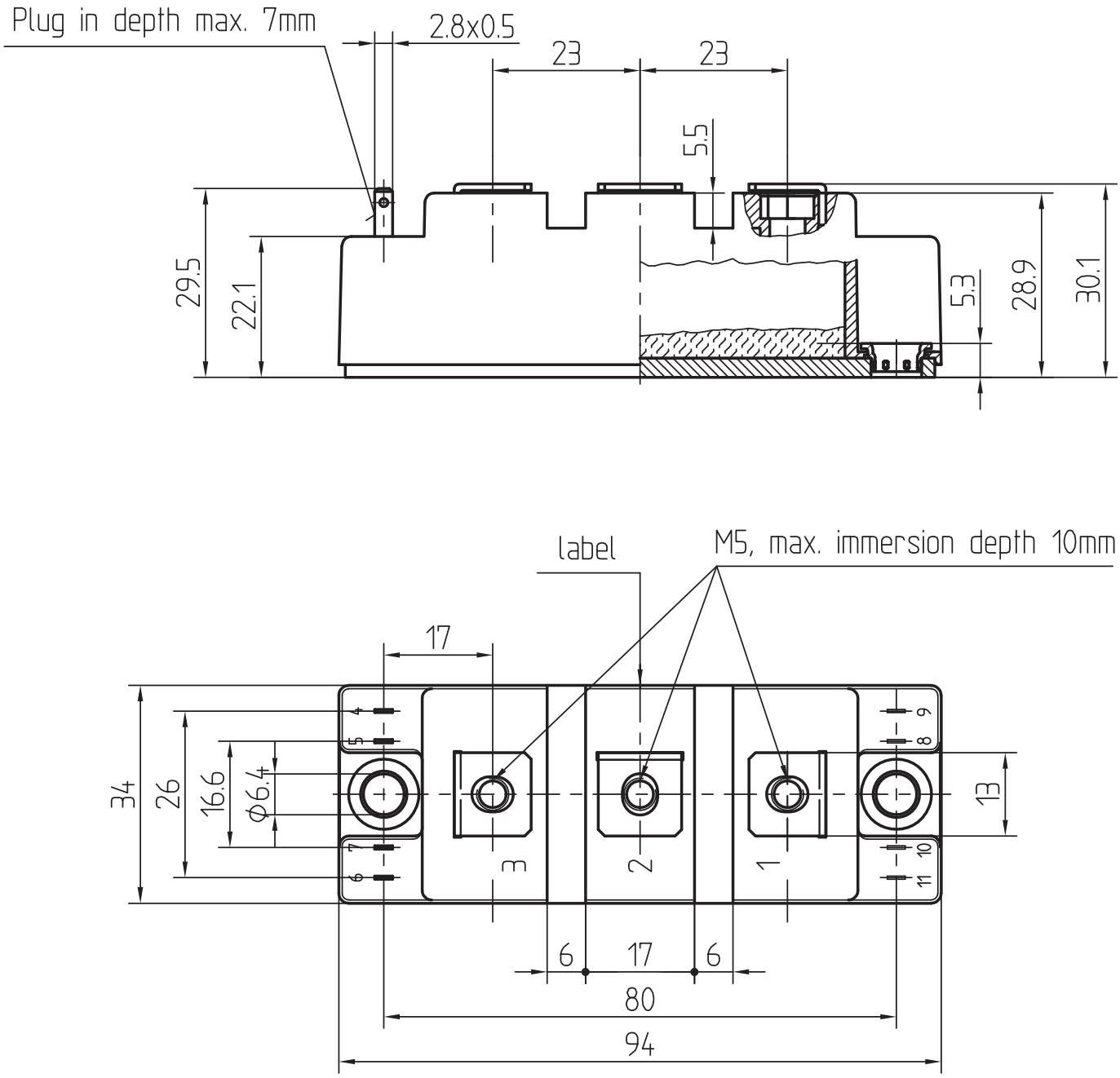


Fig. 12: Typ. CAL diode peak reverse recovery charge

Dimensions in mm



General tolerance +/- 0.5 mm

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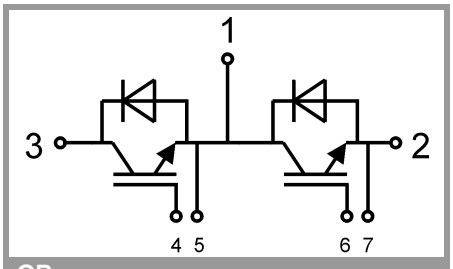

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This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

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